

Title (en)

Method and device for cutting tie bands of stacks or packs of labels and/or blanks

Title (de)

Verfahren und Vorrichtung zum Schneiden von Umreifungsbändern für Stapel von Etiketten oder Zuschnitten

Title (fr)

Procédé et dispositif pour couper des liens de piles d'étiquettes ou de flans

Publication

EP 1002729 A1 20000524 (EN)

Application

EP 99120338 A 19991012

Priority

IT SV980066 A 19981119

Abstract (en)

Method of cutting the tie bands of bundles or stacks of labels in which the band (F) is cut according to a transversal cutting line (11,111) and in which before the cut of the band (F) is carried out the same is moved away from the stack (P) in the area where the cut takes place, characterized by the fact that the moving away of the band (F) in the cutting area of the same is obtained by lifting the band from the bundle or stack (P) of blanks in direction of the cutting knife (11,111). <IMAGE>

IPC 1-7

B65B 69/00

IPC 8 full level

B65B 69/00 (2006.01)

IPC 8 main group level

A24C (2006.01); **B65B** (2006.01)

CPC (source: EP)

B65B 69/0025 (2013.01)

Citation (applicant)

IT SV980021 A 19980409

Citation (search report)

- [YA] GB 2076355 A 19811202 - TOKYO SHIBAURA ELECTRIC CO
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Designated contracting state (EPC)

DE FR GB

DOCDB simple family (publication)

EP 1002729 A1 20000524; IT 1305424 B1 20010504; IT SV980066 A0 19981119; IT SV980066 A1 20000519

DOCDB simple family (application)

EP 99120338 A 19991012; IT SV980066 A 19981119